**TOSHIBA** SHR400R22

### TOSHIBA ALLOY-FREE REVERSE CONDUCTING THYRISTOR

# SHR400R22

#### HIGH POWER CONTROL APPLICATIONS

Repetitive Peak Off-State Voltage: VDRM=1300V

R.M.S On-State Current  $: I_{T(RMS)} = 630A$ 

:  $t_{q} = 40 \mu s$  (Max.) Turn-Off Time

Flat Package

#### **MAXIMUM RATINGS**

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Repetitive Peak Off-State Voltage	$v_{ m DRM}$	1300	V	
Non-Repetitive Peak Off-State Voltage (Non-Repetitive $< 5$ ms, $T_j = 0 \sim 115$ °C)	$v_{ m DSM}$	1300	V	
R.M.S On-State Current	I <sub>T</sub> (RMS)	630	A	
R.M.S Reverse Current	I <sub>R</sub> (RMS)	235		
Average On-State Current	I <sub>T</sub> (AV)	400	A	
Average Reverse Current	I <sub>R (AV)</sub>	150		
Peak One Cycle Surge On-State	Imar	7200 (50Hz)	$f A^2 s$	
Current (Non-Repetitive)	ITSM	8000 (60Hz)		
Peak One Cycle Surge Reverse	Inass	2500 (50Hz)		
Current (Non-Repetitive)	$I_{RSM}$	2750 (60Hz)		
I <sup>2</sup> t Limit Value	I²t	$200 \times 10^{3}$ (On-Current) $31 \times 10^{3}$ (Reverse Current)		
Critical Rate of Rise of On-State Current	di/dt	100	A/μs	
Peak Gate Power Dissipation	$P_{GM}$	20	W	
Average Gate Power Dissipation	P <sub>G</sub> (AV)	4	W	
Peak Forward Gate Current	$I_{GM}$	4	A	
Peak Forward Gate Voltage	$V_{\text{FGM}}$	20	V	
Peak Reverse Gate Voltage	$v_{RGM}$	5	V	
Junction Temperature	$T_{\rm j}$	-40~115	°C	
Storage Temperature Range	$\mathrm{T_{stg}}$	-40~115	°C	
Mounting Force	_	1350~1650	kg	

Unit in mm  $2 - \phi 5.2 \pm 0.2$ DEPTH 2.0 ± 0.4 (1) - (1)(1) - (2)  $\phi$ 35 ± 0.5 260 ± 8 CATHODE (BLACK) ANODE GATE (WHITE) **JEDEC EIAJ TOSHIBA** 13-78D1A

Weight: 260g

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## **ELECTRICAL CHARACTERISTICS**

CHARACTERISTIC	SYMBOL	TEST CONDITION		MIN.	MAX.	UNIT
Repetitive Peak Off-State Current	$I_{ m DRM}$	V <sub>DRM</sub> =Rated, T <sub>j</sub> =115°C		_	35	mA
Peak On-State Voltage	$ m V_{TM}$	$I_{TM} = 1250A, T_j = 25^{\circ}C$		_	3.0	v
Peak Reverse Voltage	$v_{RM}$	$I_{RM} = 500A, T_j = 25$ °C		_	2.5	V
Gate Trigger Voltage  Gate Trigger Current	$ m v_{GT}$ $ m I_{GT}$		$Tc = -40^{\circ}C$ $Tc = 25^{\circ}C$	_	4.5 3.0	V
		$V_D=6V, R_L=6\Omega$	$Tc = -40^{\circ}C$		400	
			$Tc = 25^{\circ}C$	_	200	mA
Gate Non-Trigger Voltage	$v_{\mathrm{GD}}$	$V_D=1/2$ Rated, $T_j=115$ °C		0.15	_	V
Gate Non-Trigger Current	$I_{ ext{GD}}$			1.5	_	mA
Delay Time	$t_{ m d}$	$V_D$ =1/2 Rated, $T_j$ =25°C, Gate Supply ( $V_G$ =15V, $R_G$ =8 $\Omega$ , $t_r$ $\leq$ 1 $\mu$ s)		_	4	μs
Gate Turn-On Time	t <sub>gt</sub>			_	6	μs
Turn-Off Time	$t_q$	$I_{TM}$ =400A, $I_{R}$ =10A, $V_{DRM}$ =1/2 Rated, $dv/dt(C)$ =200V/ $\mu$ s, $T_{j}$ =115°C		_	40	μs
Holding Current	$I_{\mathrm{H}}$	$T_j=25$ °C, $R_L=6\Omega$		_	500	mA
Critical Rate of Rise of Commutating OFF-State Voltage	dv/dt(C)	$I_{TM}$ =2000A, $I_{RM}$ =1000A, $V_{DRM}$ =1/2 Rated, Pulse width $60\mu$ s, $T_j$ =115°C		200	_	V/μs
Thermal Resistance (Junction to Case)	R <sub>th (j-f)</sub>	DC		_	0.04	°C/W
Critical Rate of Rise of Off- State Voltage	dv / dt	V <sub>D</sub> =650V, T <sub>j</sub> =115°C, Gate Open, Exponential Rise		1000	_	V / μs













